No. P-JHC low height product-E002
DATE 2026-10

PRODUCTS DATA SHEET

HIGH CURRENT MICRO FUSE

TYPE JHC

Low height product 1173 SIZE

UL. cUL recognized
File No. 480488

RoHS compliant
〈Complete lead-free〉



MATSUO ELECTRIC Co., LTD.

Type JHC

As battery packs become slimmer and the number of stacked units increases, the mounting area for control boards is becoming smaller, and the electronic components used are required to be smaller and lower profile. To meet this demand, we have developed a product that is a lower profile version of the JHC type used in conventional battery packs.
By being completely lead-free, it is an environmentally friendly design.

FEATURES

1. High current rating was realized because a fuse element and a terminal adopt the structure of one.
2. This is small, low-profile, surface-mount type with dimensions of 1173 (11.0×7.3×2.6mm) .
3. This product features a revised rated voltage and is approximately less than half the height of conventional JHC models.
4. Surface temperature rise is 75°C or less when applying rated current. This gives little influence to the peripheral units.
5. Alumina ceramics are adopted as a case, original structure is adopted as the inside of a case, and the safety at the time of fusing is improved.
6. Suitable for automatic mounting
7. Complete lead-free

APPLICATION CLASSIFICATION BY USE

The application classification by use which divided the market and use into four is set up supposing our products being used for a broad use.
Please confirm the application classification by use of each product that you intend to use.
Moreover, please be sure to inform to our Sales Department in advance in examination of the use of those other than the indicated use.

RATING

Item	Rating
Category Temperature Range	-40 ～+125℃
Rated Current	25A, 30A, 40A, 50A, 60A, 80A, 100A, 125A
Rated Voltage	75VDC, 84VDC
Voltage Drop	Refer to CATALOG NUMBERS AND RATING
Insulation Resistance (between terminals and case)	1000MΩ or more
Fusing Characteristics	Fusing within 1 minute if the current is 250% of rated current.
Clearing Characteristics	Breaking voltage：Rated Voltage
	Breaking Current： Refer to CATALOG NUMBERS AND RATING

ORDERING INFORMATION

JHC 8402 253 N 26F

Type
JHC

Code	Voltage
7502	75V
8402	84V

Code	Rated current	Code	Rated current
253	25 A	603	60 A
303	30 A	803	80 A
403	40 A	104	100 A
503	50 A	134	125 A

Code	Package type
N	φ 330 Reel

Code	Case size
26F	11.0×7.3

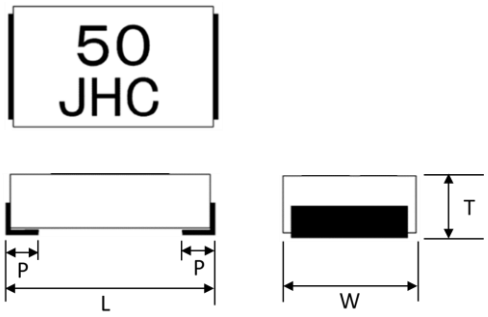
CATALOG NUMBERS AND RATING

Sep., 2026

Catalog number	Case size	Rated current A	resistance mΩ (Typical)	Voltage drop mV (Max.)	Rated voltage VDC	Breaking current A
JHC 8402 253 N 26F *2	11.0×7.3	25	1.93	100	84	1000
JHC 8402 303 N 26F *2		30	1.62			
JHC 8402 403 N 26F *2		40	1.23			
JHC 7502 503 N 26F *2		50	0.88		75	
JHC 7502 603 N 26F *2		60	0.75			
JHC 7502 803 N 26F *1		80	0.55			
JHC 7502 104 N 26F *2		100	0.47			
JHC 7502 134 N 26F *3		125	0.39			

*1：UL. cUL Recognized component
*2：Planned for UL/cUL Recognition
*3：UL. cUL Non-Recognized component

DIMENSIONS



Main body：Ceramic case
Terminal：Tin plating

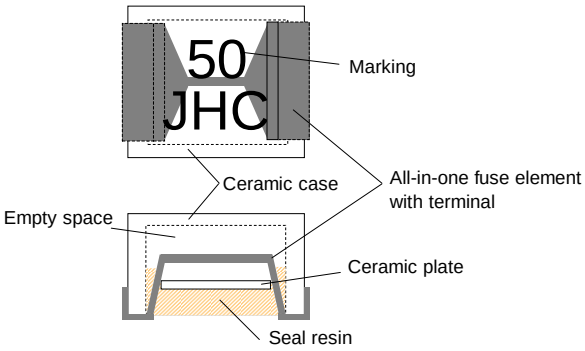
(mm)

Case size	Case code	L	W	T	P
1173	26F	11.0±0.3	7.3±0.3	2.6±0.2	1.8±0.3

MARKING

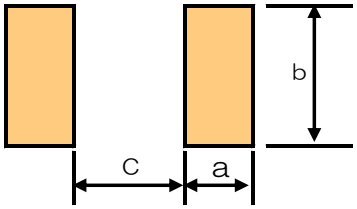
Code Rated Current	Code Rated Current
25：25A	60：60A
30：30A	80：80A
40：40A	100 100A
50：50A	125 125A

CONSTRUCTION



Name	Material, standard, and treatment
All-in-one fuse element with terminal	Copper Alloy（Tin plating terminal）
Ceramic case	Alumina ceramics
Ceramic plate	Alumina ceramics
Seal resin	Silicone resin
Marking	UV curable resin
Empty space	—

RECOMMENDED PAD DIMENSION

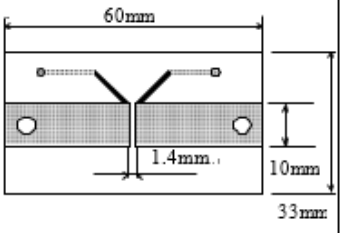
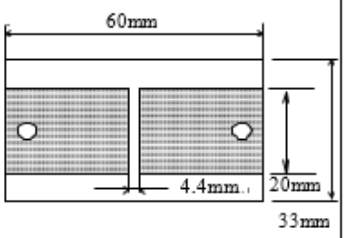
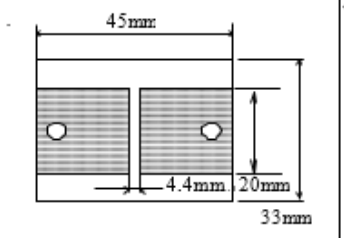


(mm)

	Size 1173
a	3.3
b	7.3
c	6.9

(Reflow)

STANDARD TEST BOARD

Rated Current 30A, 40A, 50A	Rated Current 60A, 80A	Rated Current 100A, 125A (60A, 80A also usable)
		
Glass epoxy body on one side Board thickness : 1.6mm Thickness of Copper layer : 400μm	Glass epoxy body on one side Board thickness : 1.6mm Thickness of Copper layer : 500μm	Glass epoxy body on one side Board thickness : 1.6mm Thickness of Copper layer : 500μm

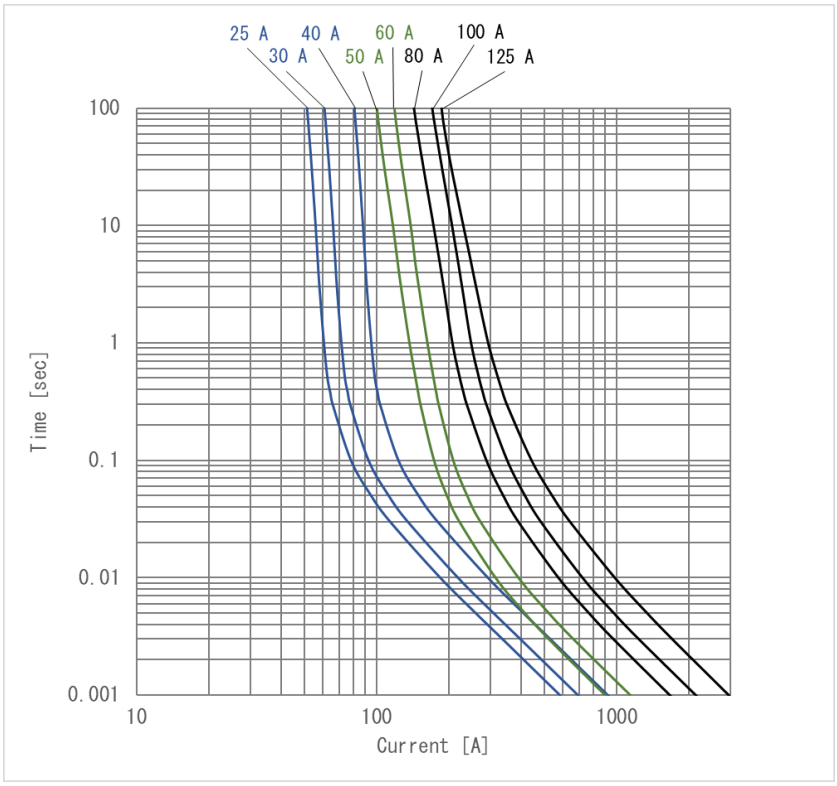
PERFORMANCE

No	Item	Performance	Test method
1	Temperature rise	Temperature rise shall not exceed 75℃	Apply rated current
2	Current-carrying capacity	Shall not open within 1 hour.	Apply 100% of rated current
3	Clearing characteristics	Arc shall not be continued. No ignition. Marking shall be legible No bursting of the fuse	Breaking voltage : Rated voltage Breaking current : Refer to CATALOG NUMBERS AND RATING
4	Voltage drop	Voltage drop is below the value specified in CATALOG NUMBERS AND RATING.	Apply rated current
5	Fusing characteristics	Fusing within I min.	Apply 250% of rated current (Ambient temperature: 10～30℃)
6	Insulation resistance	1000MΩ or more	Insulation resistance between terminals and case(ceramics)
7	Electrode strength (Bending)	No mechanical damage. Resistance change after the test shall be within ± 20%.	Board supporting width : 90mm Bending speed : Approx. 0.5mm/s Duration : 60±5 s Bending : 3mm
8	Terminal Strength (shear test)	No delamination between the terminal section and the substrate. Resistance change after the test shall be within ± 20%.	A static load : 17.7N Duration : 60s Tool : R0.5 Direction of the press : side face
9	Core body strength	No mechanical damage. Resistance change after the test shall be within ± 20%.	Supporting dimension : 3.65mm Applied force : 20N Duration : 10s Tool : R0.5 Direction of the press : thickness direction of product
10	Solderability (Solder Wetting time)	Solder Wetting time : within 3s	Solder : Sn-3Ag-0.5Cu Temperature : 245±3℃ meniscograph method
			Solder : JISZ3282 H60A, H60S, H63A Temperature : 230±2℃ meniscograph method
11	Solderability (new uniform coating of solder)	The dipping surface of the terminals shall be covered more than 95% with new solder.	Solder : Sn-3Ag-0.5Cu Temperature : 245±3℃ Dippinng : 3s
			Solder : JISZ3282 H60A, H60S, H63A Temperature : 230±2℃ Dippinng : 3s
12	Resistance to soldering heat	Marking shall be legible. No mechanical damage. Resistance change after the test shall be within ± 20%.	Dipping（1 cycle） Preconditioning : 100～150℃／60±5s Temperature : 265±3℃／6～7s Reflow（2 cycle） Preconditioning : Lower than 180℃ 1～2min Peak : 250±5℃ 5s Holding : 230～250℃ 30～40s Cooling : More than 2min Manual soldering（1 cycle） Temperature : 350±10℃ Duration : 3～4s Measure after 1hour left under room temperature and humidity.
13	Solvent resistance	Marking shall be legible. No damage to the exterior Resistance change after the test shall be within ± 20%.	Dipping rinse Solvent : Isopropyl alcohol Duration : 90s
14	Vibration	No mechanical damage. Resistance change after the test shall be within ± 20%.	Amplitude by Vibration : 5G (49m/s^2) Vibration Time : 20mm Frequency Range : 10 - 20000Hz Number of Cycles : XYZ direction, 12 cycles each (total : 36 hours)
15	Shock	No mechanical damage. Resistance change after the test shall be within ± 20%.	Maximum Acceleration : 1500G (14700m/s2) Reaction Time : 0.5ms Waveform : Half-Sine Shock Pules Velocity Variation : 4.7m/s 6 × 3 times (total: 18 times)
16	Thermal shock	No mechanical damage. Resistance change after the test shall be within ± 20%.	The following 1-2 steps as one cycle, Appplied 10 cycles in total Step 1 : -55±3℃/30±3min Step 2 : 125±2℃/30±3min within 3 min from step 1 to step 2
17	Moisture resistance	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85±3℃ Humidity : 85±5%RH Duration : 1000h
18	Load life	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85±2℃ Applied current : Rated current×70% Duration : 1000h
19	Moisture resistance load	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 85±3℃ Humidity : 85±5%RH Applied current : Rated current×70% Duration : 1000h
20	High temperature expposure (Stability)	No mechanical damage. Resistance change after the test shall be within ± 20%.	Temperature : 125±2℃ Duration : 1000h

FUSING CHARACTERISTICS

Case code: 26F

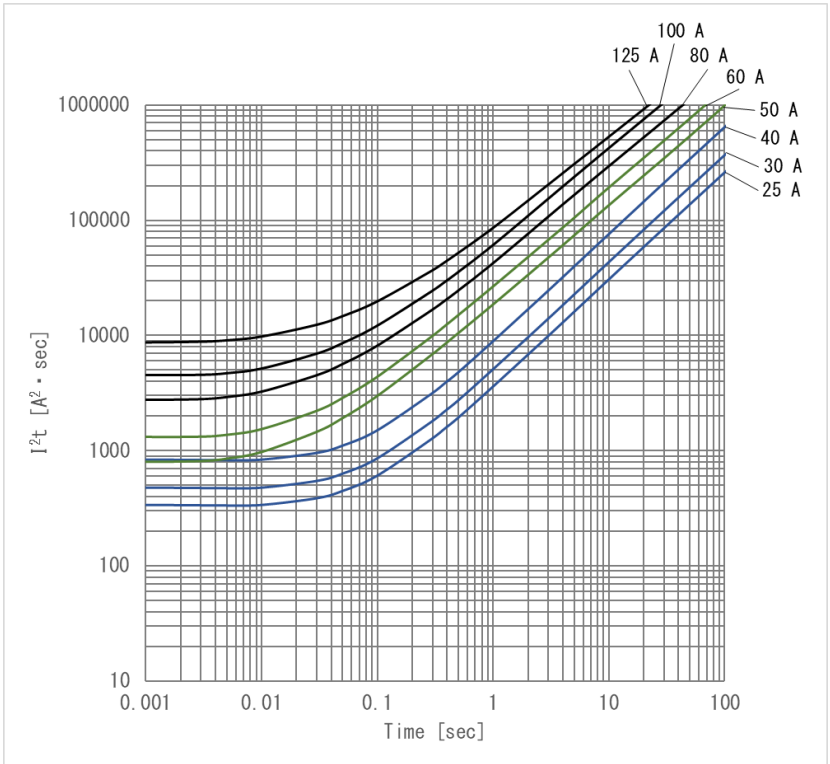
Reference



I^2T - T CHARACTERISTICS

Case code: 26F

Reference



DETERMINATION OF RATED VALUE AND SELECTION OF MICRO FUSE (TYPE JHC)

Determine the rated value of the micro fuse, and select the micro fuse for your circuit. If you select the micro fuse , safety of your circuit can be ensured.
How to determine the rated value of the micro fuse is described below:

■Flow for fuse selection

1. Measurement of circuit values using actual device
   Measure the circuit values, such as operating current of the circuit.
2. Calculation from operating current
   From the obtained operating current and the category temperature, calculate minimum rated value to determine the applicable fuse.
3. Calculation from overload current
   From the obtained overload current, calculate the maximum rated value to determine the applicable fuse.
4. Calculation from inrush current
   From the inrush current, calculate the minimum rated value to determine the applicable fuse.
5. Final determination of rated value
   From the calculation results of steps 2 through 4, determine the rated value.
6. Operation check using actual device
   After selecting the rating, confirm if the device works properly under the pre-determined conditions.

■Fuse selection

1. Measurement of circuit values using actual device
   Before determining the rated value of the fuse, preliminarily measure the following condition by using the actual device.

1-1. Operating current
   Using an oscilloscope or equivalents, measure operating current of the circuit.
1-2. Overload current
   Using an oscilloscope or equivalents, measure the overload current that needs to break the circuit.
1-3. Inrush current
   Using an oscilloscope or equivalents, measure the inrush current of circuit at power-on or power-off. In addition, determine the number of inrush current applied.
1-4. Category temperature
   Measure the ambient temperature of the fuse circuit.

<The notes to the design of substrate wiring>
   In a 25℃ environment under normal circumstances, please design substrate wiring so that the surface temperature of a fuse does not exceed 80℃.

EXAMPLE TO SELECT RATINGS OF TYPE JHC
<Fuse selection>
   Effective operating current : 30 A
   Effective overload current : 140 A
   Inrush current waveform : Fig. A
   (Pulse width : 2 ms, Wave height : 300 A)
   Numbers to withstand inrush current : 100,000 times
   Category temperature : 85°C
   Operating time : 4,000h

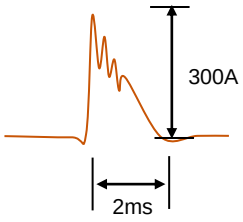
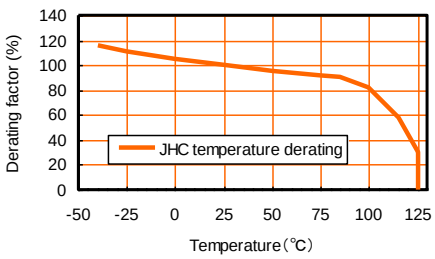


Fig. A : Inrush current waveform

2. Calculation from operating current
2–1. Measurement of operating current
   Using an oscilloscope or equivalents, measure operating current (effective current) of the actual circuit.
   Example : Effective operating current = 30 A

Fig. B



2–2 Derating
   ①Temperature derating factor
      Using Fig. B, find the temperature derating factor correspond to the Temperature. However, in order to be allowed to check an operating condition in use to the apparatus used for a long time that the operating time exceeds 4,000 h, please ask our Sales Department.
   ②Rated derating factor
      Rated derating factor = 0.94 (Constant irrespective of temperature)

      Use Formula 1 to calculate the rated current of the fuse to be used for the circuit.
      Rated current of fuse ≥ Operating current/(①×②) ... Formula 1

Example : Category temperature = 85°C, Operating current =30 A

①Temperature derating factor = 0.90 (Refer to Fig. B.)

②Rated derating factor = 0.94 (Constant irrespective of temperature)

Calculation using Formula 1 :

Rated current ≥ 30/(0.90×0.94) = 35.5A

The above calculation result shows that the fuse with rated current of 35.5A or more should be selected for this circuit.

Type JHC, with rated current of 50 A and 40A can be selected.

3. Calculation from overload current

3–1 Measurement of overload current

Using oscilloscope or equivalents, measure overload current that needs to break circuit.

Example : Effective overload current = 140 A

3–2 Calculation from overload current

Determine rated current so that overload current can be 2.5 times larger than rated current.

Use Formula 2 to calculate rated current of fuse.

Rated current of fuse ≤ Overload current/2.5 ... Formula 2

Example : Overload current = 140 A

Use Formula 2 to calculate the rated current.

Rated current ≤ 140/2.5 = 56 A

The above calculation result shows that the fuse with rated current of 56 A or less should be selected for this circuit.

Type JHC, with rated current of 50 A and 40A can be selected.

4. Calculation from inrush current

4–1 Measurement of inrush current waveform

Using an oscilloscope or equivalent, measure waveform of inrush current of actual circuit.

4–2 Creation of approximate waveform

Generally, waveform of inrush current is complicated. For this reason, create the approximate waveform of inrush current as shown on Fig. C to simplify calculation.

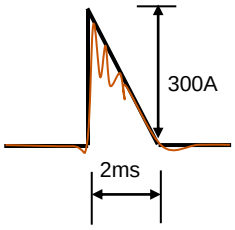


Fig. C：Inrush current waveform
Red line : Actual measurement waveform
Black line：Approximate waveform

4–3 Calculation of I^2t of inrush current

Calculate I^2t (Joule integral) of approximate waveform.

The formula for this calculation depends on the approximate waveform.

Refer to Table A.

Example : Pulse applied = 2 ms, Peak value = 300 A

Approximate waveform = Triangular wave

Since the approximate waveform is a triangular wave, use the following formula for calculation.

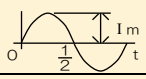
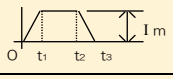
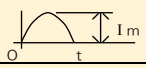
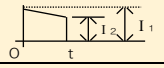
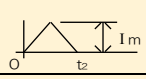
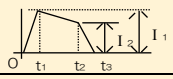
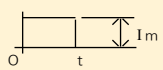
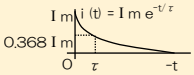
I^2t of rush current = 1/3 × Im^2 × t ... Formula 3 (Im : Peak value, t : Pulse applying time)

Use Formula 3 to calculate I2t of the inrush current:

I^2t = 1/3 × 300 × 300 × 0.002 = 60 (A^2s)

JOULE-INTEGRAL VALUES FOR EACH WAVEFORM

Table A

Name	Waveform	I^2t	Name	Waveform	I^2t
Sine wave (1cycle)		$\frac{1}{2} I_m^2 t$	Trapezoidal wave		$\frac{1}{3} I_m^2 t_1 + I_m^2 (t_2-t_1) + \frac{1}{3} I_m^2 (t_3-t_2)$
Sine wave (half cycle)		$\frac{1}{2} I_m^2 t$	Various wave 1		$I_1 I_2 t + \frac{1}{3} (I_1-I_2)^2 t$
Triangular wave		$\frac{1}{3} I_m^2 t$	Various wave 2		$\frac{1}{3} I_1^2 t_1 + \{I_1 I_2 + \frac{1}{3} (I_1-I_2)^2\} (t_2-t_1) + \frac{1}{3} I_2^2 (t_3-t_2)$
Rectangular wave		$I_m^2 t$	Charge/ discharge waveform		$\frac{1}{2} I_m^2 \tau$

* Following formula is generally used for calculation of I^2t as i(t) equal to current.

$$I^2 t = \int_0^t i^2 (t)\, dt$$

4-4 Search of load ratio

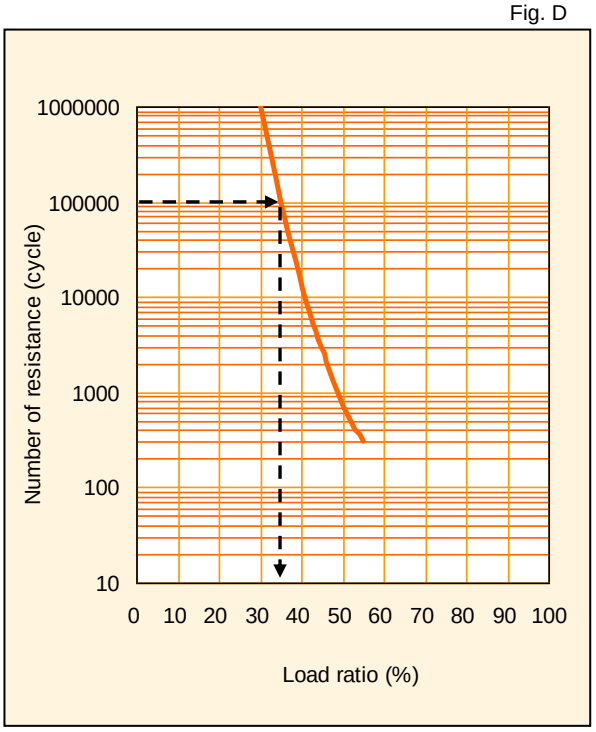
①Set up number of cycles to withstand.
(generally 100,000 times)

②Obtain load ratio from Pulse resistance characteristics.
(Fig. D)

Example : 100,000 times is required against inrush current applied.
The load ratio is 35% or less from Fig. D.

PULSE RESISTANCE CHARACTERISTICS

Fig. D



4–5 Calculation from Joule integral and load ratio

Use Formula 4 to calculate the standard I^2t for the fuse to be used.

Standard I^2t of fuse > (I^2t of inrush current/load ratio) .....
.....Formula 4

Example : I^2t of pulse = 60 A2s,
Pulse applied = 2 ms, Required load ratio = 35%

From Formula 4,

Standard I^2t of fuse > 60/0.35 = 171.4 (A2s)

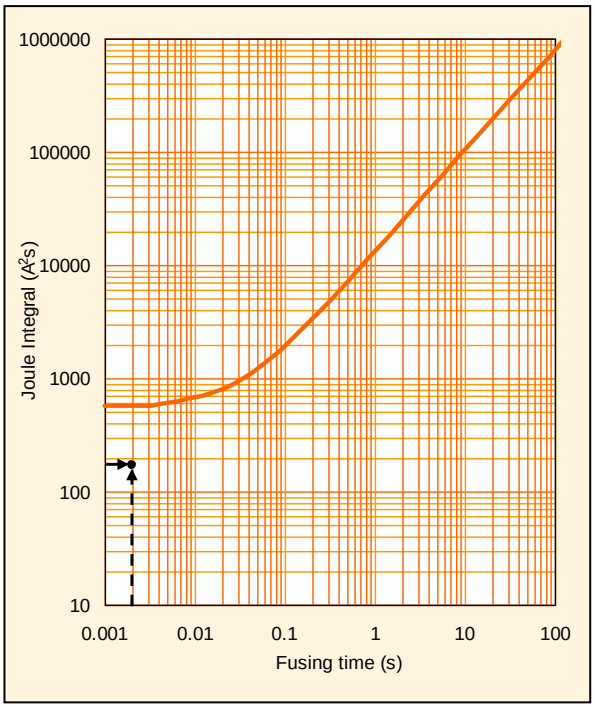
The standard I^2t of the fuse should be 171.4 (A2s) or more.

Since the rush pulse applied is 2 ms, obtain the intersection of 2 ms (horizontal axis) and 171.4 A2s (vertical axis) from Fig. E (refer to the arrow shown in Fig. E).

Select a fuse whose curve is above the intersection. Type JHC with rated current of 50 A and 40A should be selected.

JOULE INTEGRAL VS. FUSING TIME

Fig. E



5. Final determination of rated value

Determine the rated current of micro fuse. Rated current should meet all the calculation results.

Example : Rated current of 50 A and 40A meets the all requirement.

6. Operation check using actual device

After selecting rating, confirm if the device works properly under pre-determined conditions.

Application Notes for Micro Fuse

1. Circuit Design

Before using High Current Micro Fuse, be sure to fully check after confirming operating conditions and Micro Fuse characteristics.
When determining the rated current, be sure to observe the following items :
(1) High Current Micro Fuse should always be operated below the value considered in the rated derating rate and temperaturederating rate for rated current.
(2) High Current Micro Fuse should always be operated below rate for rated current.
(3) High Current Micro Fuse should be selected with rated value to be certainly fused at overload current.
(4) When High Current Micro Fuse are used in inrush current applications, please confirm sufficiently inrush resistance of High Current Micro Fuse.
(5) Please do not apply the current exceeding the rated breaking current to High Current Micro Fuse.
In addition, I would like confirmation beforehand not to have possibilities to cut if off normally when you uses it by a high inductance circuit.
(6) Use High Current Micro Fuse under the condition of category temperature.
(7) High Current Micro Fuse should not be used in the primary power source (AC side).
(8) In a 25°C environment under normal circumstances, please design substrate wiring so that the surface temperature of a fuse does not exceed 80°C.
And, please use after checking that turn on operating current and overload current by an actual substrate in advance, and it is satisfactory.

Please confirm whether the selection of the rating of High Current Micro Fuse was appropriate in the actual device (state of final product).
In that case, after considering the variation due to the product, repeat the tests for normal use and predictable abnormalities to confirm the validity of the selection.

2. Assembly and Mounting

During the entire assembly process, observe High Current Micro Fuse body temperature and the heating time specified in the performance table. In addition, observe the following items :
(1) Mounting and adjusting with soldering irons are not recommendable since temperature and time control is difficult.
(2) Once High Current Micro Fuse mounted on the board, they should never be remounted on boards or substrates.
(3) During mounting, be careful not to apply any excessive mechanical stresses to the High Current Micro Fuse.

3. Solvents

High Current Micro Fuse has no effect when immersed in is isopropyl alcohol for 90 seconds (at 20 ~ 30°C liquid temp.)
If organic solvents will be used to High Current Micro Fuse, be sure to preliminarily check that the solvent will not damage High Current Micro Fuse .

4. Ultrasonic Cleaning

Ultrasonic cleaning is not recommended for High Current Micro Fuse. This may cause damage to High Current Micro Fuse such as broken terminals which results in electrical characteristics effects, etc. depending on the conditions.

5. Caution During Usage

(1) High Current Micro Fuse with electricity should never be touched.
High Current Micro Fuse with electricity may cause burning due to High Current Micro Fuse high temperature.
Also, in case of touching High Current Micro Fuse without electricity, please check the safety temperature of High Current Micro Fuse.
(2) Protective eye glasses should always be worn when performing fusing tests.
However, there is a fear that High Current Micro Fuse will explode during test.
During fusing tests, please cover particles not to fly outward from the board or testing fixture. Caution is necessary during usage at all times.

6. Environmental Conditions

(1) High Current Micro Fuse should not be stored or operated in the presence of acids, or alkalis, or corrosive atmosphere.
(2) High Current Micro Fuse should not be vibrated, shocked, or pressed excessively.
(3) High Current Micro Fuse should not be operated in a flammable or explosive atmosphere.
(4) High Current Micro Fuse should not be used under dew condensation environment.
(5) Covering High Current Micro Fuse with resin after mounting it on the board may affect the electrical characteristics, so perform thorough evaluation in advance.

7. Emergency

In case of fire, smoking, or offensive odor during operation, please cut off the power in the circuit or pull the plug out.

8. Storage

(1) High Current Micro Fuse should not be stored in an environment with high temperature, low temperature, high humidity, condensation and dust and avoid direct sunlight.
High Current Micro Fuse should not be stored in corrosive atmosphere such as H2S(hydrogen sulfide) or SO2(sulfur dioxide).
Direct sunlight may cause decolorization and deformation of the exterior and taping.
Also, there is a fear that solderability will be remarkably lower in high humidity.
(2) If the products are stored for an extended period of time, please contact Matsuo Sales Department for recommendation. The longer storage term causes packages and tapings to worsen. If the products are stored for longer term, please contact Matsuo Sales Department for advice.
(3) The products in taping, package, or box should not be given any kind of physical pressure. Deformation of taping or package may affect automatic mounting.
(4) The plastic reel (made of PS) used for packaging the product is intended for use in ambient temperatures (5-35℃). To prevent issues during automated insertion due to reel deformation or other factors, please keep the reel away from direct sunlight and heat sources, and ensure it does not reach high temperatures (above 60℃), including during transportation.

9. Disposal

When High Current Micro Fuse are disposed of as waste or “scrap”, they should be treated as “industrial waste”.

10. Samples

High Current Micro Fuse received as samples should not be used in production applications. A sample is provided for the special use (in such cases as the one for the form sample, the electriccharacteristic confirmation)

MATSUO ELECTRIC CO., LTD.

Please feel free to ask our Sales Department for more information on Micro Fuse.

Overseas Sales 5-3,3-Chome,Sennari-cho,Toyonaka-shi,Osaka 561-8558,Japan Tel:06-6332-0883 Fax:06-6332-0920
Head office 5-3,3-Chome,Sennari-cho,Toyonaka-shi,Osaka 561-8558,Japan Tel:06-6332-0871 Fax:06-6331-1386
URL https://www.ncc-matsuo.co.jp/

Specifications on this catalog are subject to change without prior notice. Please inquire of our Sales Department to confirm specifications prior to use.

適用用途分類 / APPLICATION CLASSIFICATION BY USE

Rev.7 (2025.10.03)

市場	適用用途分類	用途		推奨品種	推奨品種
		概要	代表的なアプリケーション例	チップタンタルコンデンサ	回路保護素子
高信頼度機器	1	・高度な安全性や信頼性が要求される機器 ・製品の保守交換が不可能な機器、製品の故障が人命に直接かかわる、または、致命的なシステムダウンを引　き起こす可能性がある機器	・宇宙開発機器関連(衛星、ロケット、人工衛星) ・航空・防衛システム ・原子力・火力・水力発電システム	267型Pシリーズ	該当なし
車載・産業機器	2	・信頼性が重視される機器 ・製品の保守交換が極めて困難な機器や、製品の故障が人命に影響する、あるいは故障の範囲が広範囲である機器	・自動車および鉄道・船舶等の輸送機器の車両制御(エンジン制御,駆動制御,ブレーキ制御) ・新幹線・主要幹線の運行制御システム	267型Nシリーズ 271型Nシリーズ	JAG型Nシリーズ JAJ型Nシリーズ JAK型Nシリーズ JHC型Nシリーズ KAB型Nシリーズ KVA型Nシリーズ
	3-A	・車載用だが一般電装機器で車室内環境において使用される機器	・エアコン,カーナビ等の車室内搭載部品、　車載用通信機器		KAB型Mシリーズ
	3-B	・製品の保守交換が可能な機器や、製品の故障が人命に影響しないが故障によるシステムダウンの損失が大きく保全管理が要求される機器	・家庭用/ビル用等のセキュリティ管理システム ・工業用ロボットや工作機械等の制御機器	267型M,Eシリーズ 279型 281型M,Eシリーズ TCA型 TCD型	JHC型
汎用機器	4	・最先端技術を積極的に適用する小型・薄型品 ・製品の保守交換が可能な機器や、製品の故障によるシステムダウンが部分的な機器向けの市場で広く使用されることを想定した製品	・スマートフォン、携帯電話、モバイルPC(タブレット)、電子辞書 ・デスクトップPC、ノートPC、ホームネットワーク ・アミューズメント機器(パチンコ、ゲーム機)	251型Mシリーズ 267型Cシリーズ TCB型	JAE型、JAG型 JAJ型、JAK型 KAB型 KAB型Tシリーズ KVA型

Market	Application classification by use	Use		Recommendation Type	Recommendation Type
		Outline	Typical example of application	Chip Tantalum Capacitors	Circuit Protection Components
High reliability apparatus	1	- Apparatus in which advanced safety and reliability are demanded. - Whether failure of the apparatus which cannot maintenance exchange products, and a product is direct for a human life, apparatus which changes or may cause a fatal system failure.	- Space development apparatus relation (Satellite, Rocket, Artificial Satellite) - Aviation and a defensive system - Atomic power, fire power, and a water-power generation system	Type 267 P Sereis	With no relevance
In-vehicle - Industrial apparatus	2	- Apparatus in which reliability is important. - The apparatus in which maintenance exchange of a product is very difficult, and failure of a product influence a human life, or the range of failure is wide range.	- Vehicles control of transport machines, such as a car, and a railroad, a vessel (Engine control, drive control, brake control) - The operation control system of the Shinkansen and a main artery	Type 267 N Sereis Type 271 N Sereis	Type JAG N series Type JAJ N series Type JAK N series Type JHC N series Type KAB N series Type KVA N series
	3-A	- General electrical equipment designed for use in vehicles but used in the interior environment	- Vehicle indoor loading parts, such as an air-conditioner and car navigation, and in-vehicle communication facility		Type KAB M series
	3-B	-Apparatus which can maintenance exchange products, and apparatus in which the loss of the system failure is large although failure of a product does not influence a human life, and maintenance engineering is demanded	- Security management system for home/buildings etc. - Control apparatus, such as Industrial use robots and a machine tool etc.	Type 267 M,E Sereis Type 279 Type 281 M,E Sereis Type TCA Type TCD	Type JHC
Apparatus in general	4	- The small size and the thin article which applies leading-edge technology positively - The product supposing being used widely in the market for the apparatus which can maintenance exchange products, and apparatus with a partial system failure by failure of product.	-Smart phone, Mobile phone, Mobile PC (tablet), Electronic dictionary - Desktop PC, Notebook PC, Home network - Amusement apparatus (Pachinko,Game machine)	Type 251 M Series Type 267 C Series Type TCB	Type JAE, Type JAG Type JAJ, Type JAK Type KAB Type KAB T series Type KVA

テーピング数量・リール寸法
Taping Quantity And Carrier Tape Dimensions

チップタンタルコンデンサ
Chip Tantalum Capacitors

定格：251型Mシリーズ, TCB型
Type：251 M Series, TCB

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	ϕD_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330 ※1
U	1.0×0.5	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	2.0±0.05	4.0±0.1	1.55±0.03	10,000	-
M	1.6×0.8				4.0±0.1			$1.5^{+0.1}_{0}$	3,000	15,000
S	2.0×1.25									10,000
A	3.2×1.6									-

※1. 251 type only.

定格：267型Mシリーズ, 267型Eシリーズ, 267型Pシリーズ, 271Nシリーズ
279型Mシリーズ, 281型Mシリーズ, 281型Eシリーズ
Type：267 M Series, 267 E Series, 267 P Series, 271 N Series
279 M Series, 281 M Series, 281 E Series

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
A	3.2×1.6	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	$\phi 1.5^{+0.1}_{0}$	2,000	9,000
B	3.5×2.8									8,000
C3	6.0×3.2	12.0±0.3	5.5±0.05		8.0±0.1				500	3,000
D3	7.3×4.4		5.7±0.05	1.5±0.1						2,500
H	7.3×4.4		5.7±0.1							1,500
E	7.3×5.8		5.5±0.05	1.75±0.05						2,000

定格：267型Nシリーズ、TCA型
Type：267 N Series, TCA

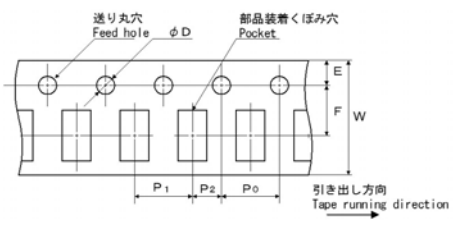
ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
A	3.2×1.6	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	$\phi 1.5^{+0.1}_{0}$	2,000	9,000
B	3.5×2.8									8,000
C	6.0×3.2	12.0±0.3	5.5±0.05		8.0±0.1				500	3,000
D	7.3×4.4		5.7±0.05	1.5±0.1						2,500

回路保護素子
Circuit Protection Components

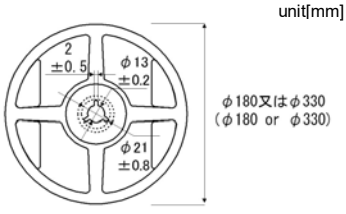
定格：JAE型、JAG型、JAG型Nシリーズ、JAJ型、JAJ型Nシリーズ、JAK型、JAK型Nシリーズ、JHC型、JHC型Nシリーズ
KAB型、KAB型Nシリーズ、KAB型Mシリーズ、KAB型Tシリーズ、KVA型、KVA型Nシリーズ
Type：JAE, JAG, JAG N Series, JAJ, JAJ N Series, JAK, JAK N Series, JHC, JHC N Series
KAB, KAB N Series, KAB M Series, KAB T Series, KVA, KVA N Series

ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P_1 (mm)	P_2 (mm)	P_0 (mm)	D_0 (mm)	包装数/リール(個) Quantity/Reel (pcs)	
									ϕ180	ϕ330
29	1.6×0.8	8.0±0.3	3.5±0.05	1.75±0.05	4.0±0.1	2.0±0.05	4.0±0.1	ϕ1.55±0.03	5,000	-
31	2.0×1.25									-
52	3.2×1.6			1.75±0.1				ϕ1.5±0.1	2,000	-
44E	7.3×5.8	12±0.3	5.5±005		8.0±0.1			$\phi 1.5^{+0.1}_{0}$	500	1,500
26F	11.0×7.3	24±0.3	11.5±005		12.0±0.1				-	1,500
59F									-	500

テーピング寸法/Tape dimensions



リール寸法/Reel dimensions　単位[mm]
unit[mm]



チップタンタルコンデンサ テーピング形状記号
Chip Tantalum Capacitors Tape code

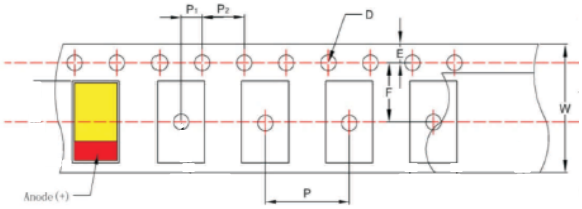
φ180リール φ180Reel	φ330リール φ330Reel	極性 Anode notation
L	P	送り穴側 ＋ Feed hole ＋
R	N	送り穴側 － Feed hole －

チップタンタルコンデンサ
Chip Tantalum Capacitors

定格：TCD型
Type：TCD

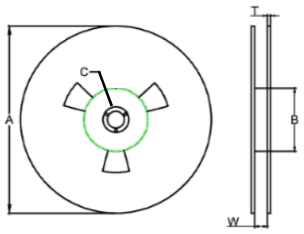
ケース記号 Case Code	ケースサイズ Case size	W (mm)	F (mm)	E (mm)	P (mm)	P_1 (mm)	P_2 (mm)	φD (mm)	包装数/リール(個) Quantity/Reel (pcs)
									φ180
B	3.5×2.8×2.1	8±0.30	3.5±0.05	1.75±0.10	4±0.10	4±0.10	2±0.10	1.55±0.20	2,000
D	7.3×4.3×2.8	12±0.30	5.5±0.05	1.75±0.10	4±0.10	8±0.10	2±0.10	1.55±0.20	500

テーピング寸法/Tape dimensions



単位[mm]
unit[mm]

リール寸法/Reel dimensions



リール Reel	テープ幅 Tape width	A	B	C	W	T
φ180	12	178±2.00	50 min	13.0±0.50	12.4+1.5/-0	1.50±0.50